


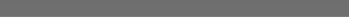
























Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Overlay		0mm	
2		Top Solder	SM-001	0.035mm	4
3		Top Surface Finish	ENIG	0.017mm	
4		Top	CF-003	0.018mm	
5		Dielectric 1	1080	0.07mm	4.7
6		Dielectric 2	1080	0.07mm	4.7
7		Int1 (Sig)	CF-004	0.035mm	
8		Dielectric 3	Core-024	0.2mm	4.7
9		Int2 (Gnd)	CF-004	0.035mm	
10		Dielectric 4	1080	0.07mm	4.7
11		Dielectric 5	PP-003	0.115mm	4.7
12		Dielectric 6	1080	0.07mm	4.7
13		Int3 (Sig)	CF-004	0.035mm	
14		Dielectric 7	Core-024	0.2mm	4.6
15		Int4 (Sig)	CF-004	0.035mm	
16		Dielectric 8	1080	0.07mm	4.7
17		Dielectric 9	PP-003	0.115mm	4.7
18		Dielectric 10	1080	0.07mm	4.7
19		Int5 (Pwr)	CF-004	0.035mm	
20		Dielectric 11	Core-024	0.2mm	4.7
21		Int6 (Sig)	CF-004	0.035mm	
22		Dielectric 12	1080	0.07mm	4.7
23		Dielectric 13	1080	0.07mm	4.7
24		Bottom	CF-003	0.018mm	
25		Bottom Surface Finish	ENIG	0.017mm	
26		Bottom Solder	SM-001	0.035mm	4
27		Bottom Overlay		0mm	
	Height : 1.74001mm				